

Electronic Acknowledgement Receipt

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Title of Invention:	Stacked interconnect structure between copper lines of a semiconductor circuit
First Named Inventor:	Stephan Grunow
Customer Number:	23494
Filer:	Jacqueline J. Garner./Marianna Smith
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Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1	Response to Election / Restriction Filed	T35917Election.pdf	4111	no	2

Warnings:			
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<p>National Stage of an International Application under 35 U.S.C. 371 If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.</p>			